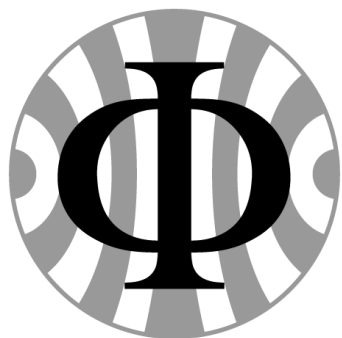


Irradiation Studies on single HBT Test Structures

Benjamin Weinläder

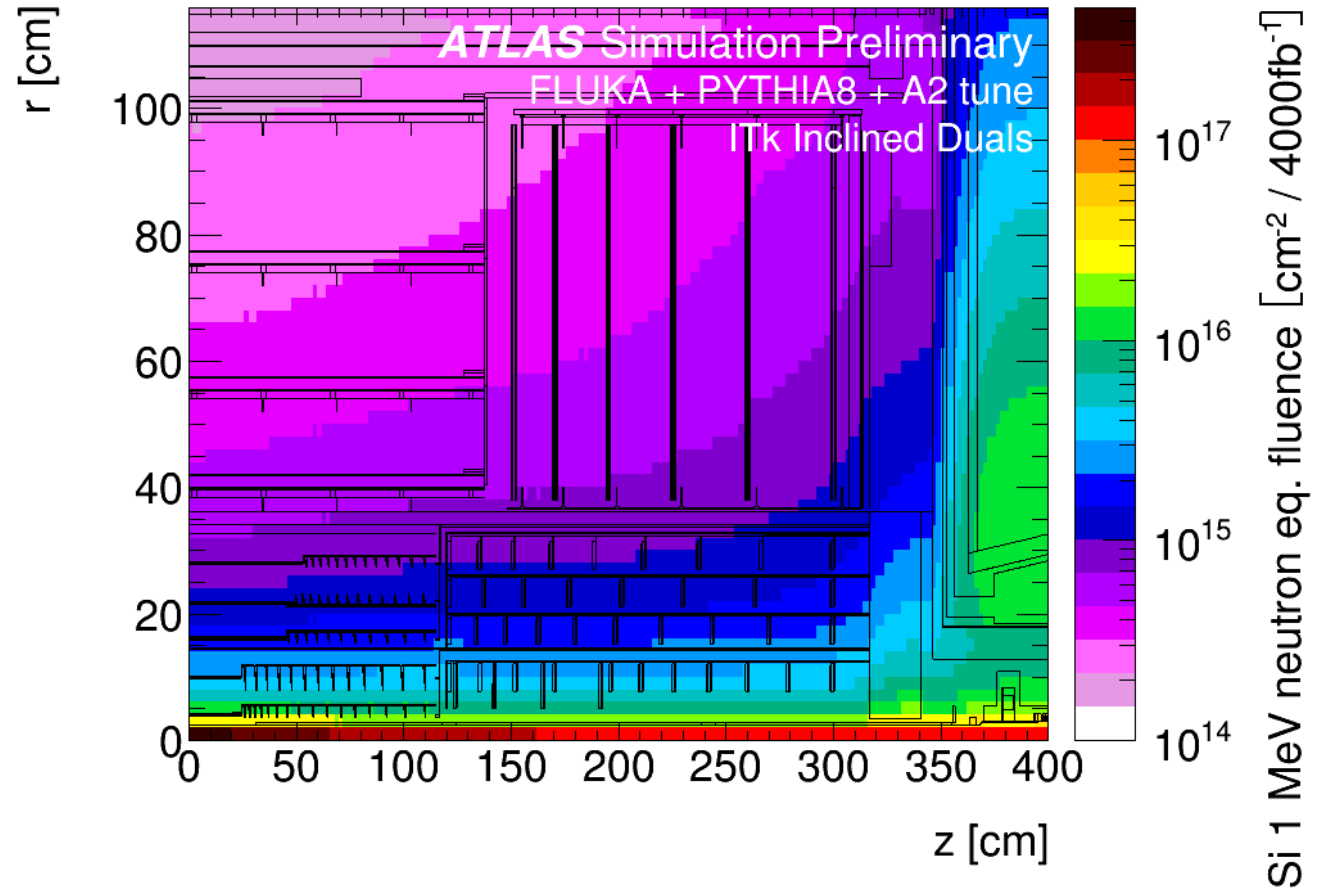
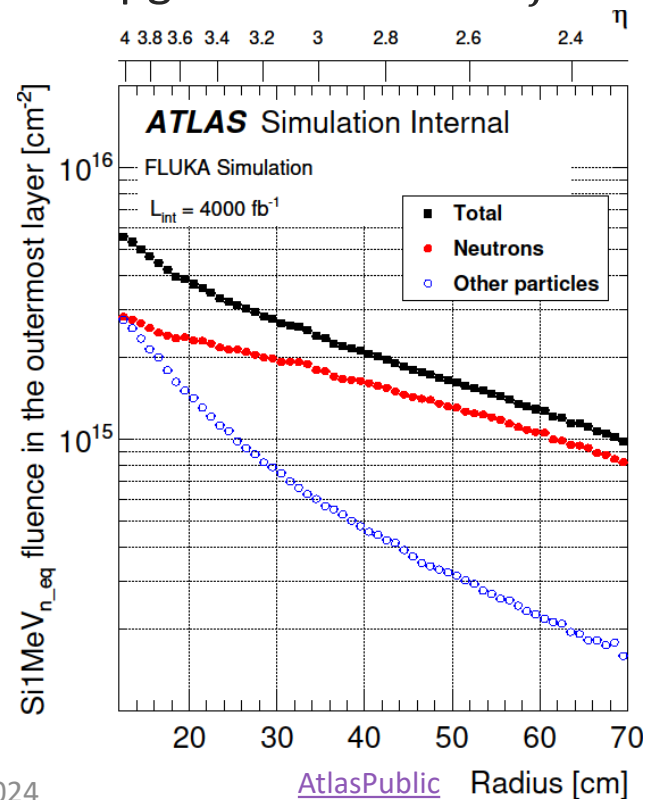
06.03.2024

HighRR Seminar



Radiation Environment in HEP

- Example: Atlas Inner Tracker
- Simulations for the HL-LHC upgrade after 4000 fb^{-1}



Radiation Damage

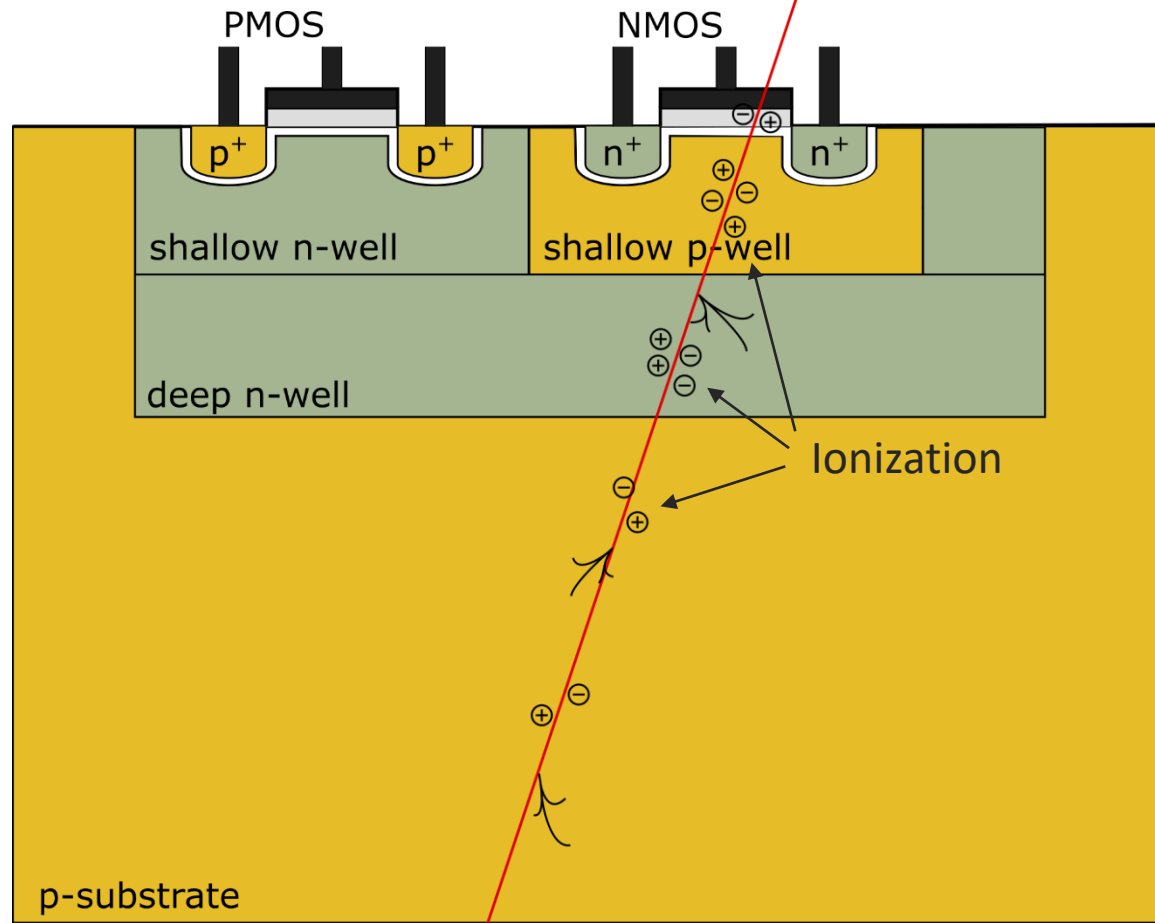
Dose Effects

- Slowly, over time
 - Accumulation of defects/trapped charge
 - Shift of transistor properties
 - Increase of leakage current

Single Event Effect

- Directly visible effect
 - Latch-up: Short, thus thermal destruction
 - Upset: Bit flips, errors in the digital part
 - Gate rupture: Destruction of the gate isolation

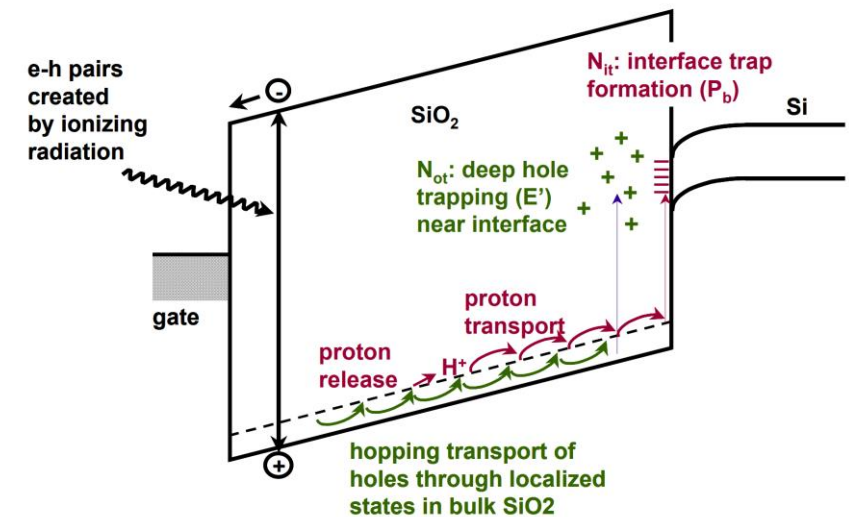
Radiation Damage



Incident charged Particle

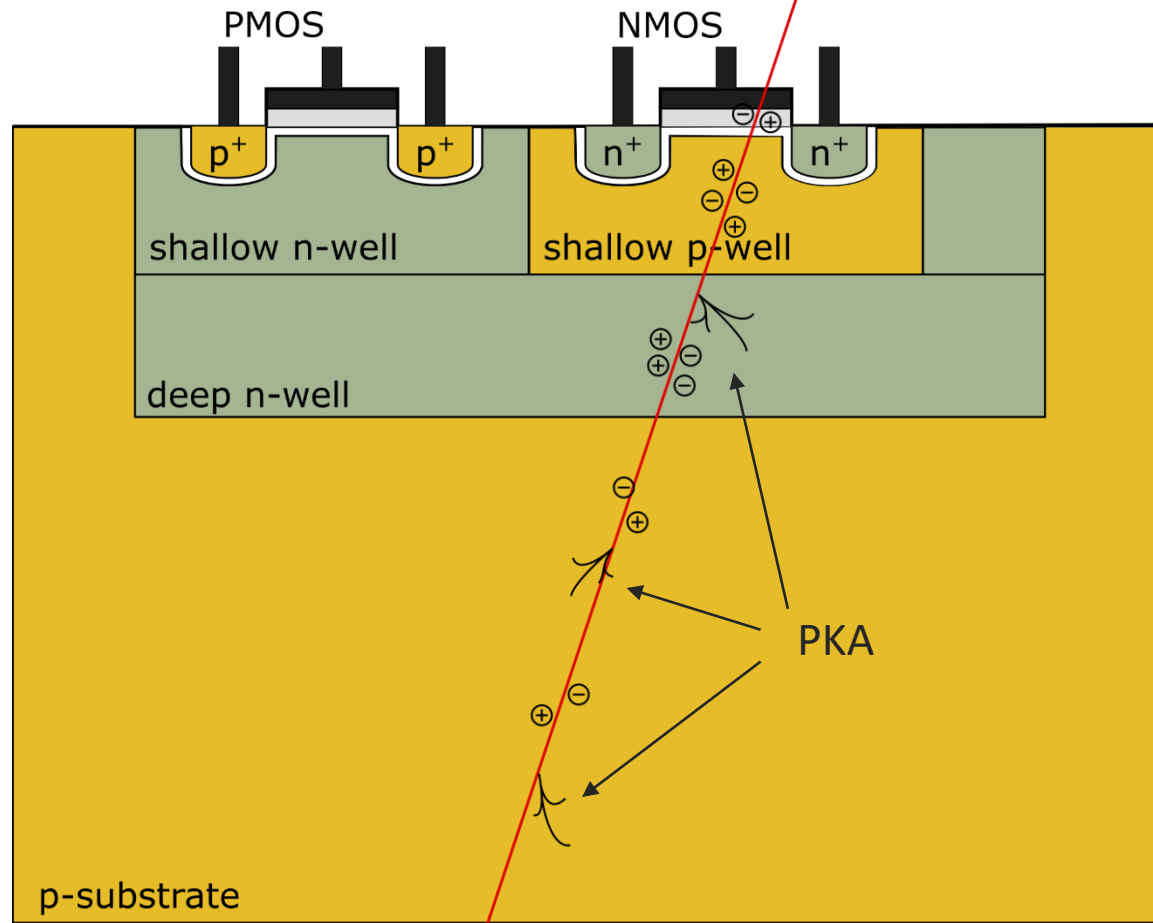
Ionization

- Silicon:
 - Charge recombines or is removed by existing elec. Fields
- Oxide:
 - Holes get trapped, accumulate at the surface
 - ! Change transistor threshold voltage !
 - ! Increase leakage current !



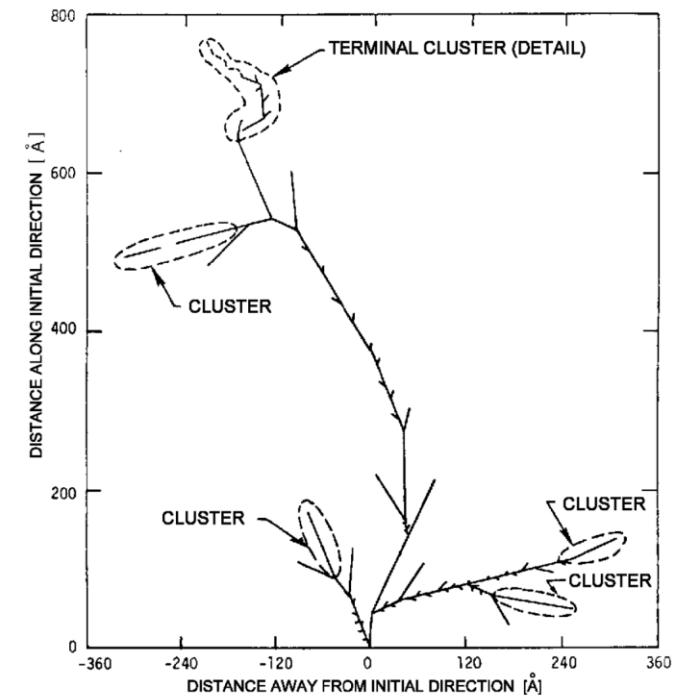
DOI: [10.1109/TNS.2008.2001040](https://doi.org/10.1109/TNS.2008.2001040)

Radiation Damage



Primary Knock on Atom (PKA)

- Displacement of a lattice atom
 - Impact energy $\geq 25eV$ (depending on direction)
 - Recoils knock out additional atoms + energy transfer via ionization

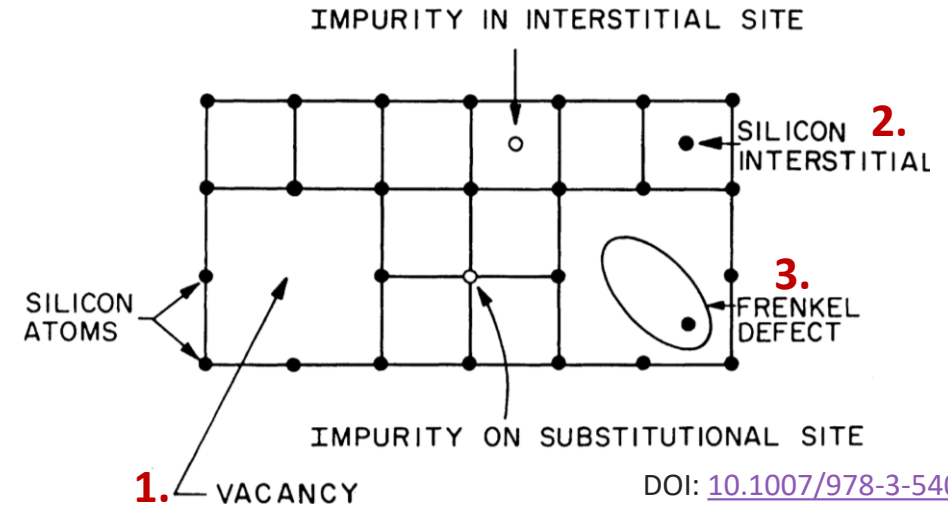


[Van Lint et al., 1980](#)

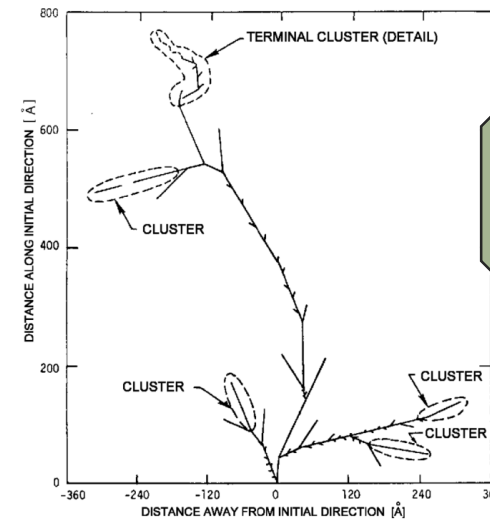
Primary Knock on Atom

Different types of lattice defects

- Point defects
 1. Vacancies → empty lattice sites
 2. Interstitials → atoms outside the regular lattice
 3. Frenkel defects → combining both
- Clusters
 - Aggregation of point defects
 - Typically at the end of a recoil track
 - Scattering cross-section increases with decreasing energy



DOI: [10.1007/978-3-540-71679-2](https://doi.org/10.1007/978-3-540-71679-2)



Simulation of a PKA
with $E_R = 50\text{keV}$

[Van Lint et al., 1980](#)

Electric Properties of Defects

- **Recombination-generation center**

- Capture or emit charge carriers
 - ! Increase of leakage current at junctions !
 - ! Shift in a transistor threshold voltage !

- **Trapping center**

- Capture charge carriers and re-emits them with time delay
 - ! Generates timing-jitter on signals !

- **Change of charge density**

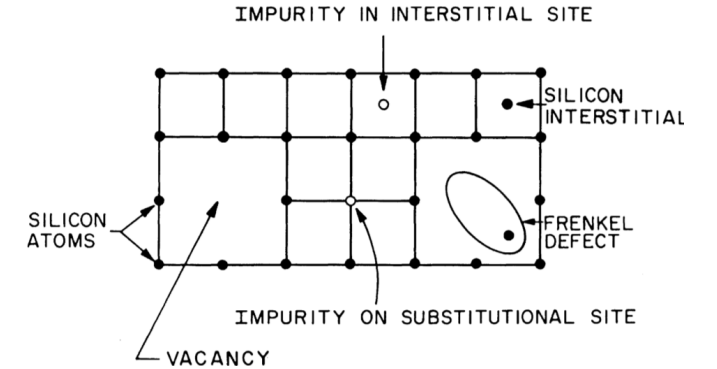
- ! Change of the effective resistivity !

Also holds for defects caused by ionization

Increased hole density at the oxide surface → recombination-generation center

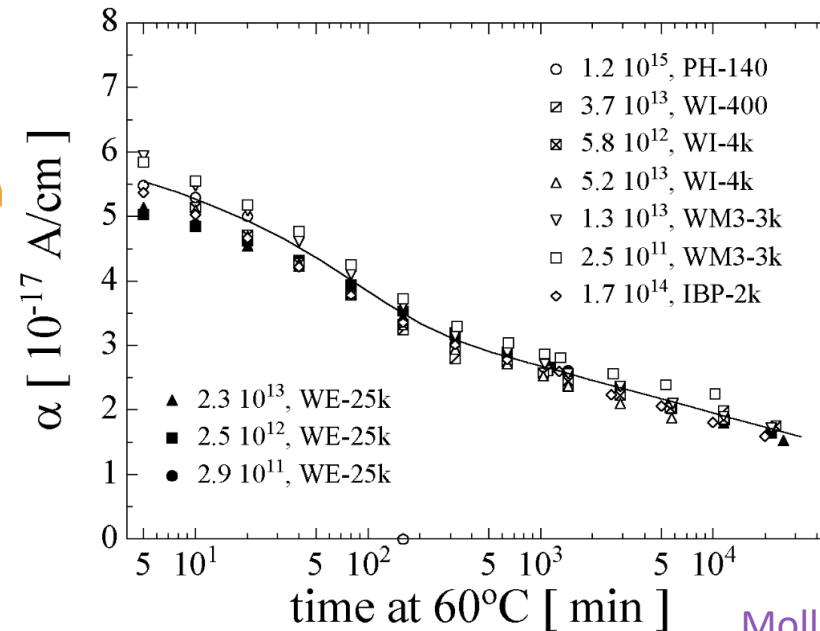
Annealing

- Position of most lattice defects are not fixed
 - At certain temperatures defects become mobile
 - Possibility to recombine with the respective counterpart increases
- Depends on temperature and time



DOI: [10.1007/978-3-540-71679-2](https://doi.org/10.1007/978-3-540-71679-2)

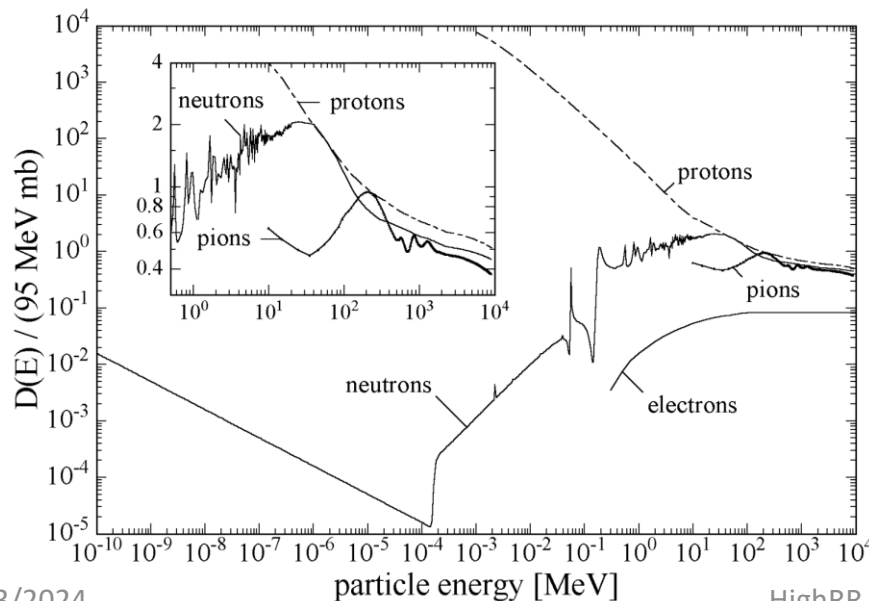
~ leakage current
of diodes



[Moll, 1999](#)

Non Ionizing Energy Loss hypotheses

- Radiation damage depends on the incident particle type and energy
 - Differences are smoothed due to secondary interactions
- Radiation damage \leftrightarrow Non Ionizing Energy Loss (NIEL)
 - $NIEL \sim D(E) \leftarrow$ Displacement damage function
 - Normalized to 1MeV Neutrons: $D_n(1MeV) = 95MeVmb$



[Moll, 1999](#)

Hardness factor κ

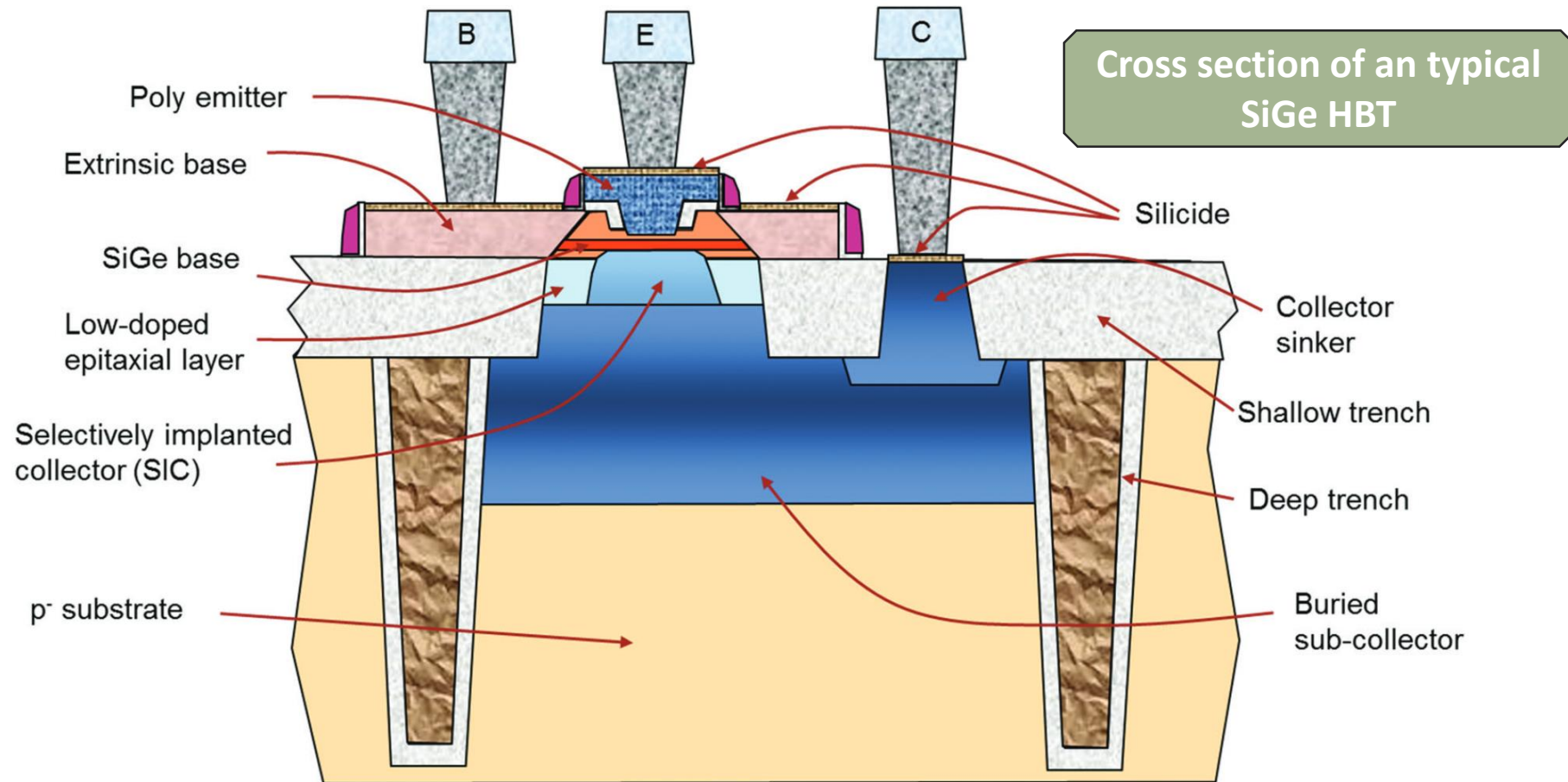
- $\kappa = \frac{\int D(E)\phi(E)dE}{D_n(1MeV) \cdot \int \phi(E)dE}$

- Equivalent fluence:

$$\Phi_{eq} = \kappa \cdot \Phi = \kappa \cdot \int \phi(E)dE$$

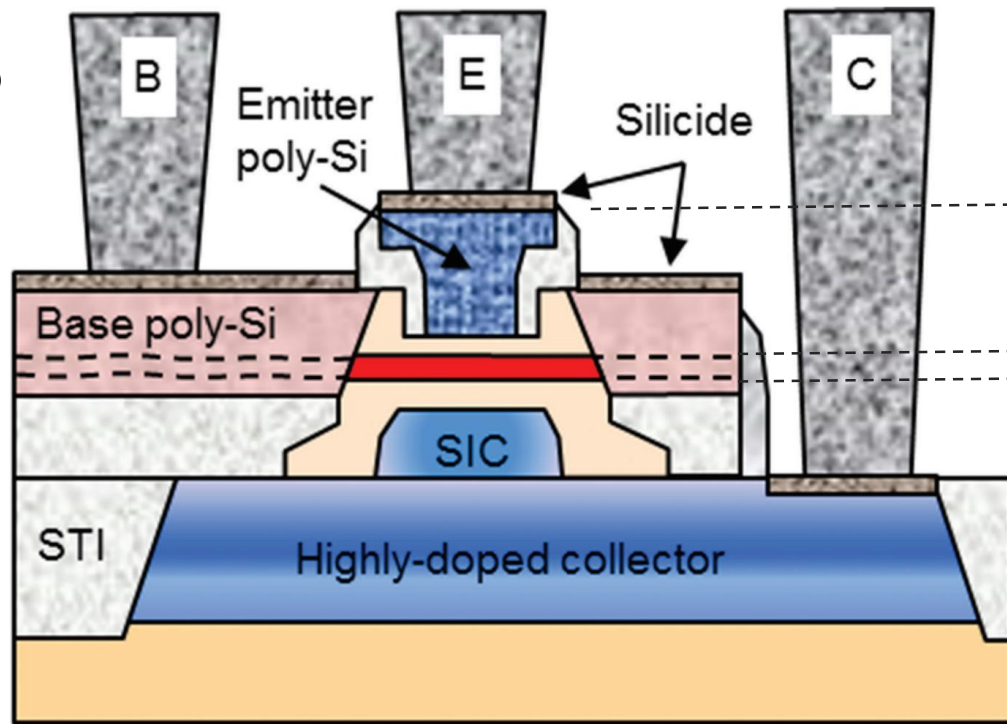
Individual energy spectra $\phi(E)$

Heterojunction Bipolar Transistor



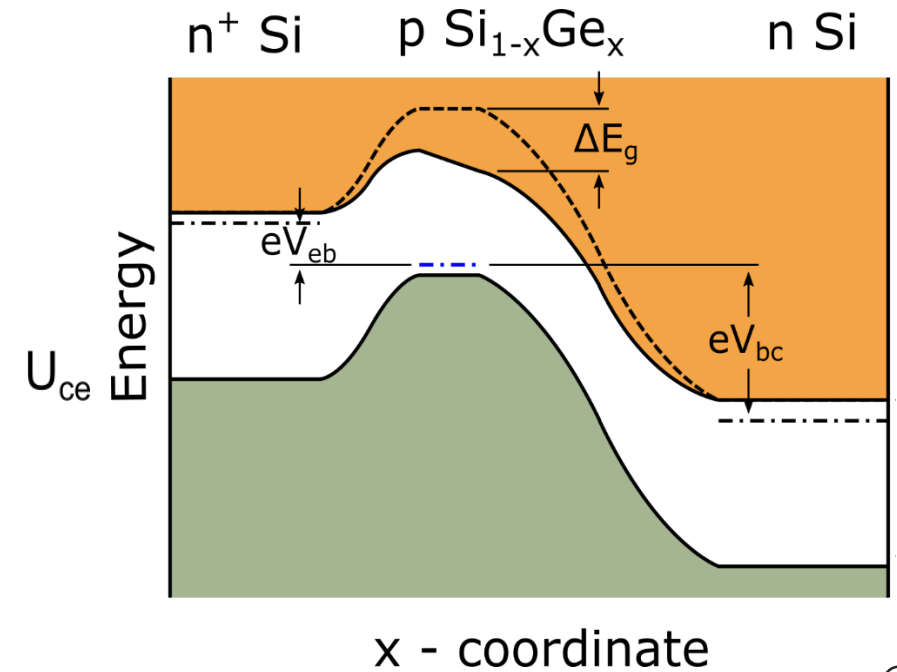
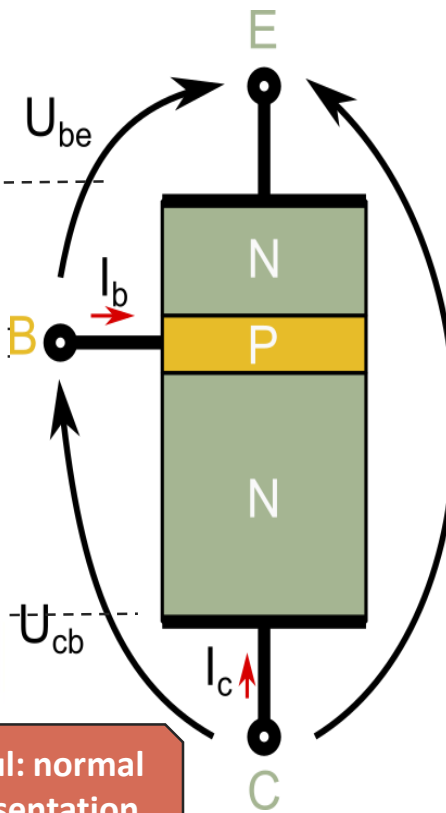
DOI: [10.1201/9781003339519-2](https://doi.org/10.1201/9781003339519-2)

Heterojunction Bipolar Transistor

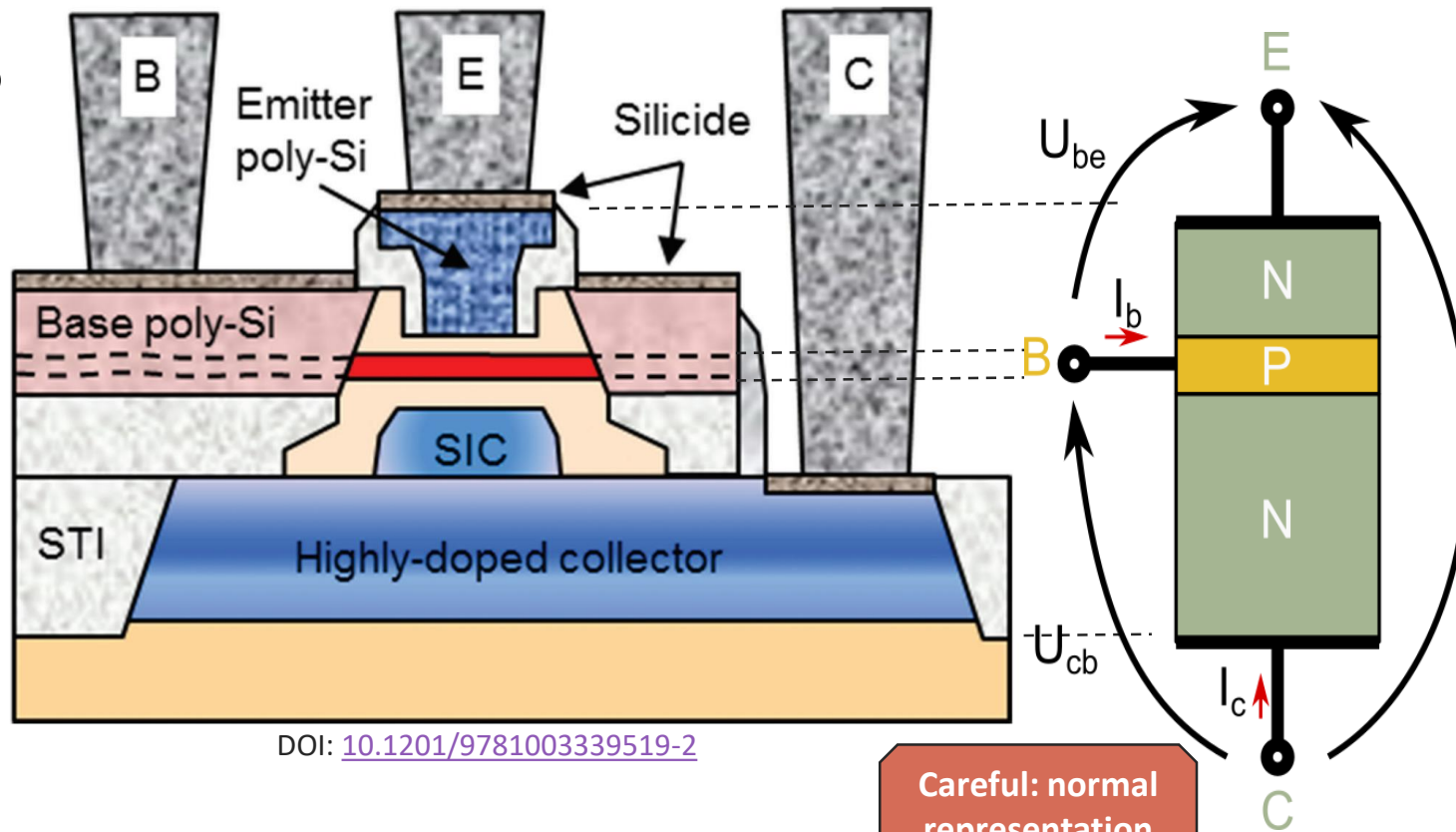


DOI: [10.1201/9781003339519-2](https://doi.org/10.1201/9781003339519-2)

Careful: normal representation rotated by 180°



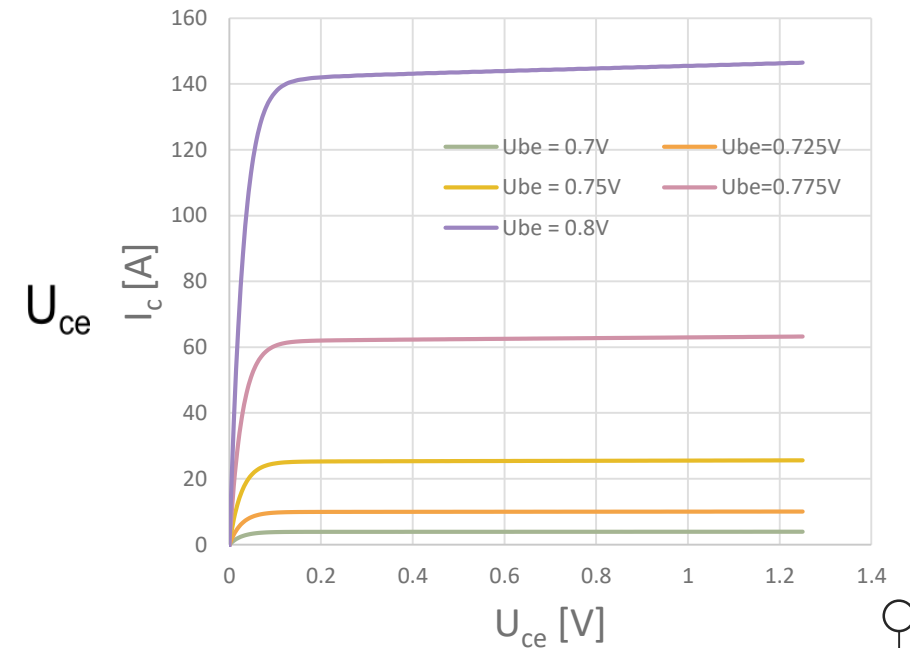
Heterojunction Bipolar Transistor



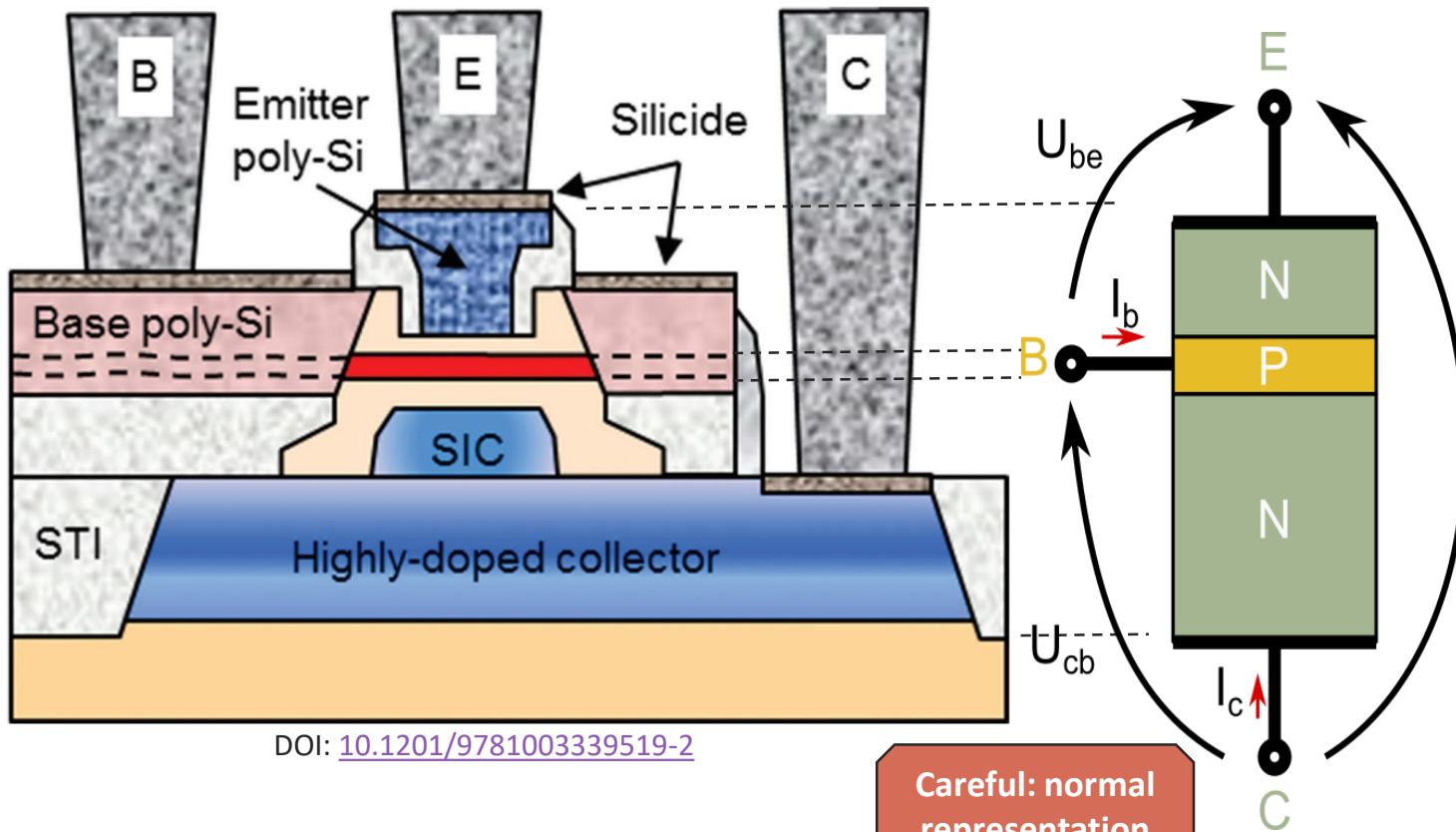
DOI: [10.1201/9781003339519-2](https://doi.org/10.1201/9781003339519-2)

Careful: normal representation rotated by 180°

Characteristic Curve



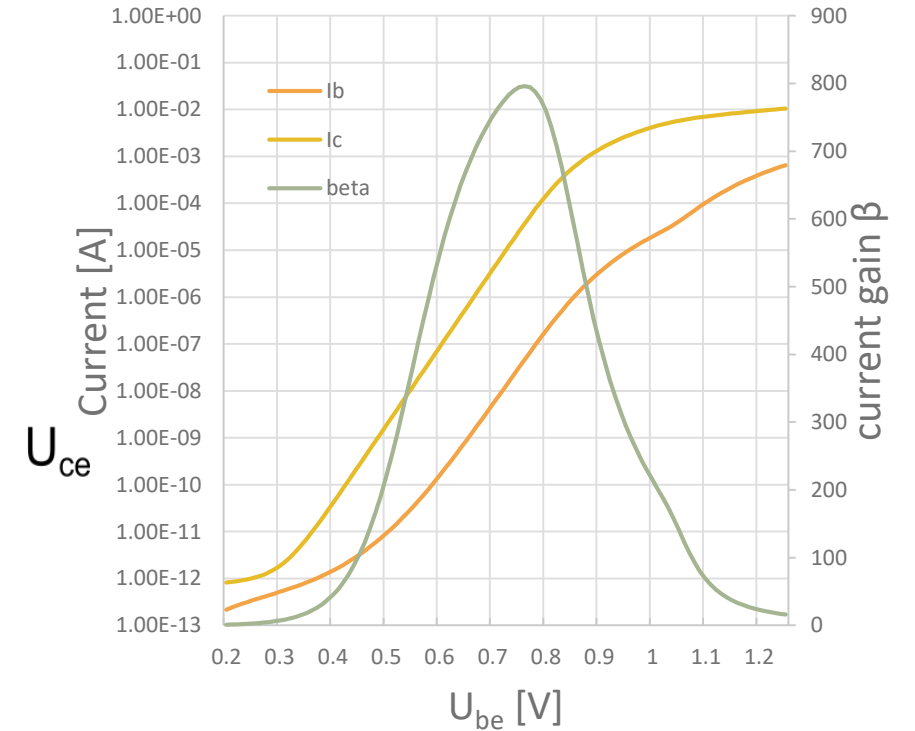
Heterojunction Bipolar Transistor



DOI: [10.1201/9781003339519-2](https://doi.org/10.1201/9781003339519-2)

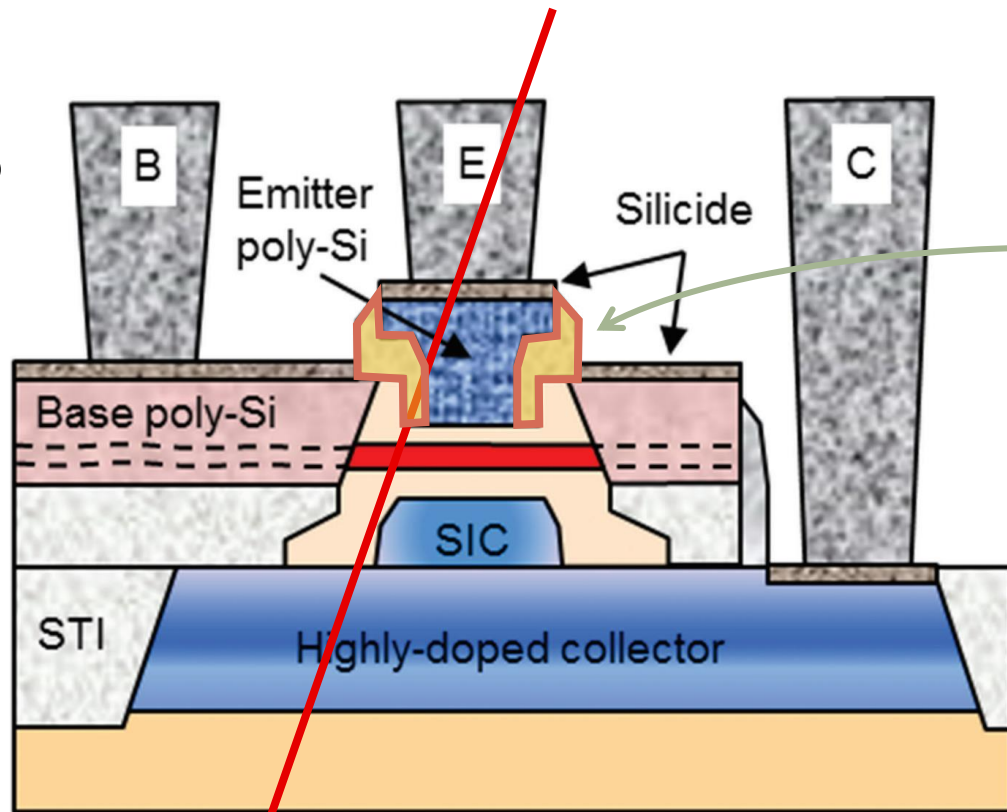
Careful: normal representation rotated by 180°

Gummel Poon Representation



$$\text{Current gain } \beta = \frac{I_c}{I_b}$$

Heterojunction Bipolar Transistor



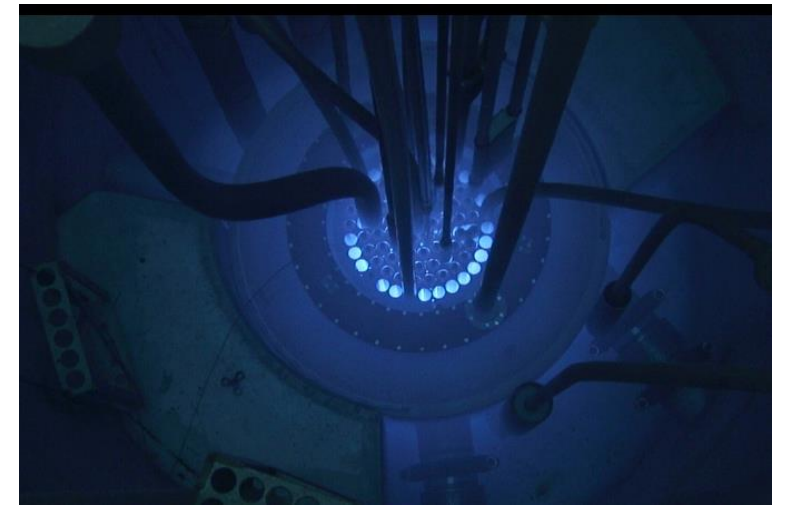
Expected radiation damage

- Ionization:
 - Trapped charge emitter-base spacer oxide
 - Forming a **generation-recombination center**
 - Additional recombination/ leakage current
 - Increase in I_b
 - Especially dominate for low V_{be} as

DOI: [10.1201/9781003339519-2](https://doi.org/10.1201/9781003339519-2)

Incident Particle

05/03/2024



[Institut Jožef Stefan](#)

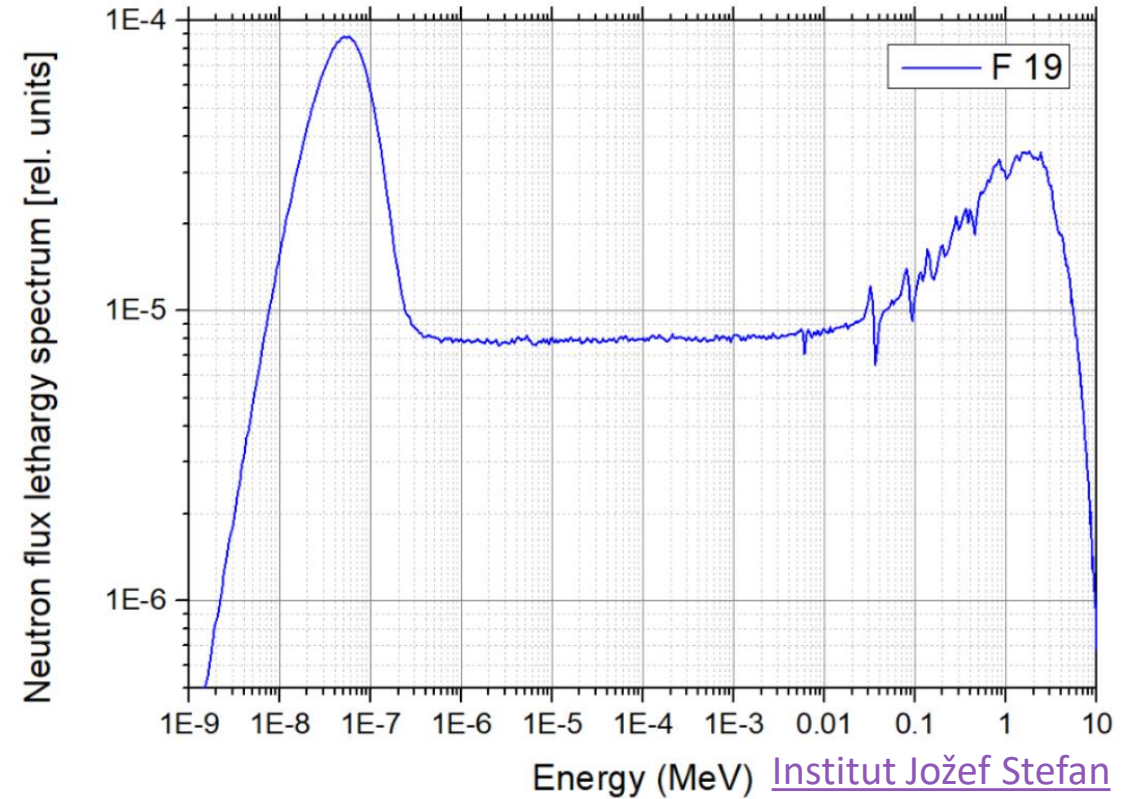
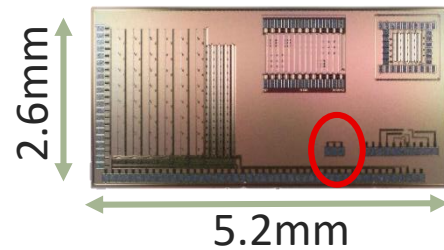
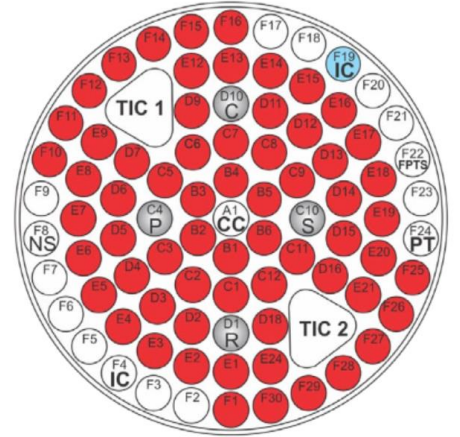
Neutron irradiation

Irradiation at the **Reactor Infrastructure Centre in Ljubljana**

Research TRIGA reactor

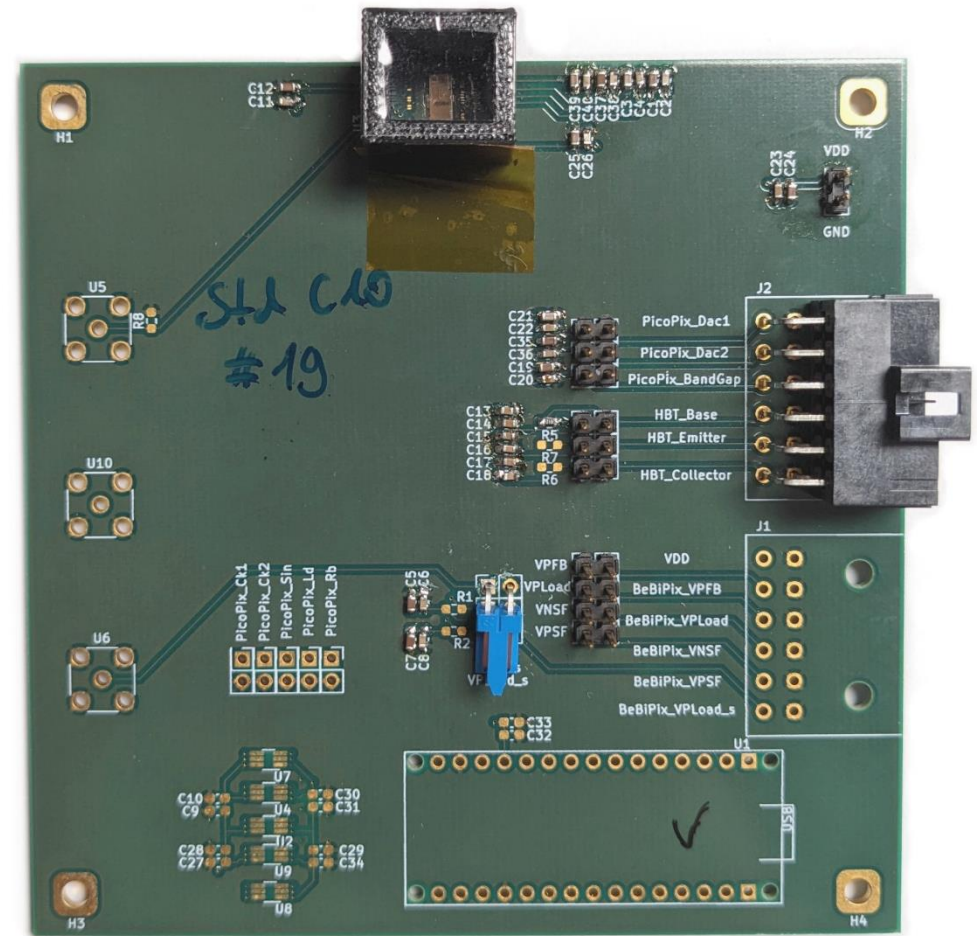
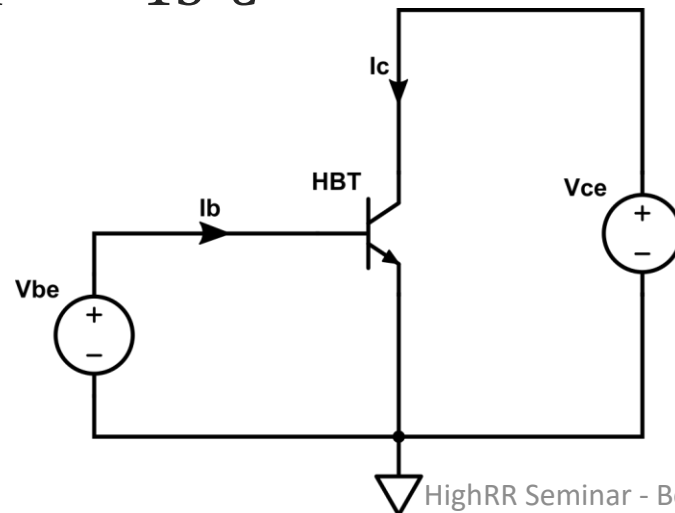
Neutron irradiation

- Irradiation at the **Reactor Infrastructure Centre in Ljubljana**
 - Research TRIGA reactor



Setup

- Irradiated samples are glued and wire bonded on a test PCB
 - Stored in the freezer to minimize annealing
- HBT is powered via 2 Source Measure Units (SMUs)
 - Voltage is applied while currents are measured
- All measurements are done within a climate chamber at $T = -15^{\circ}\text{C}$



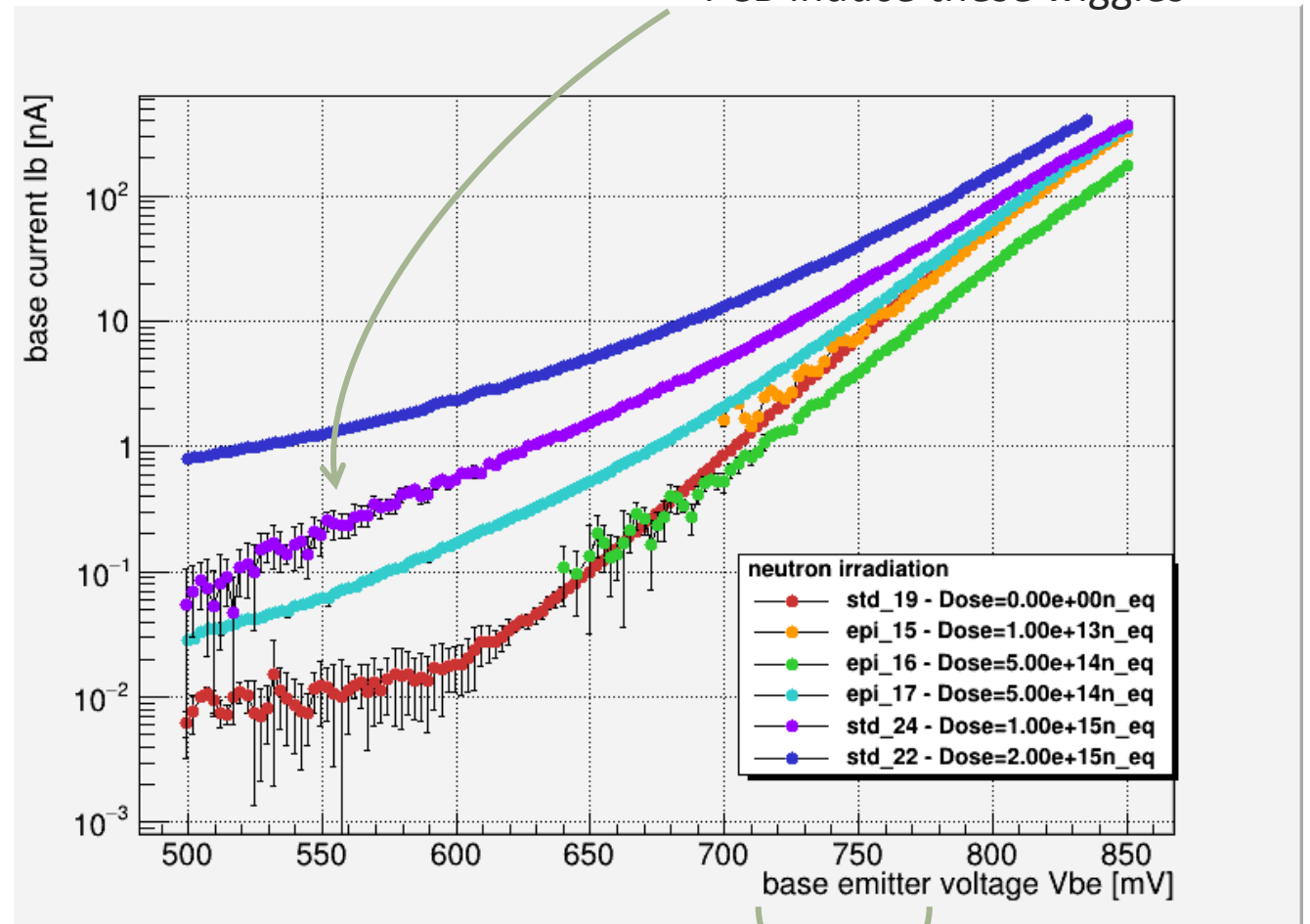
Results after irradiation

Decoupling capacities on PCB induce these wiggles

Base current I_b

- As expected: clear increase of the base current
 - More dominate at low V_{be}
- Chip 'epi_16' clear outlier
 - Could be sensor-to-sensor variation

Reference measurement before irradiation would help a lot

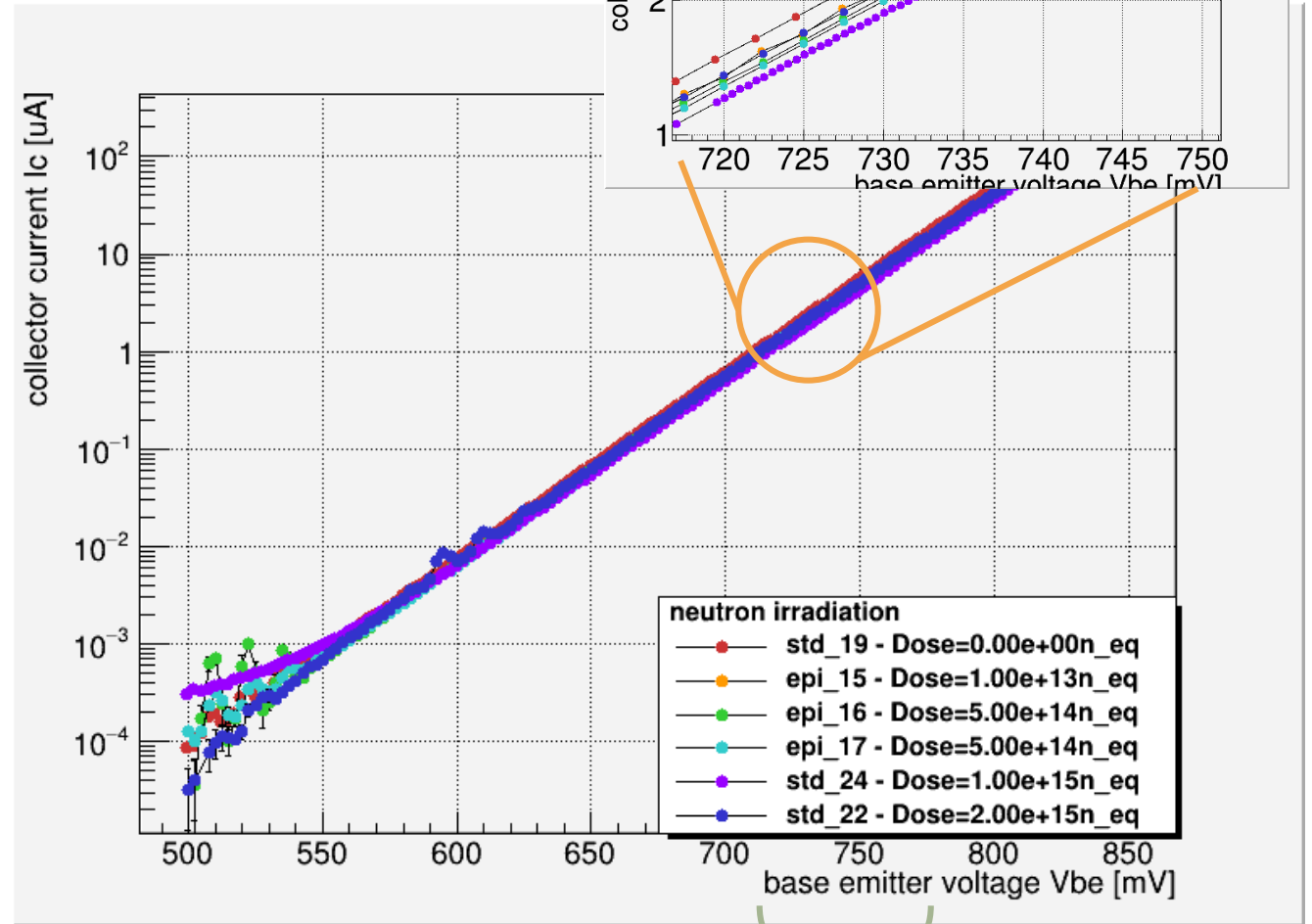


Typical operation range

Results after irradiation

Collector current I_c

- No significant dependency visible
 - Overall slight decrease after irradiation, but no direct relation
 - Most probably dominated by chip-to-chip variations

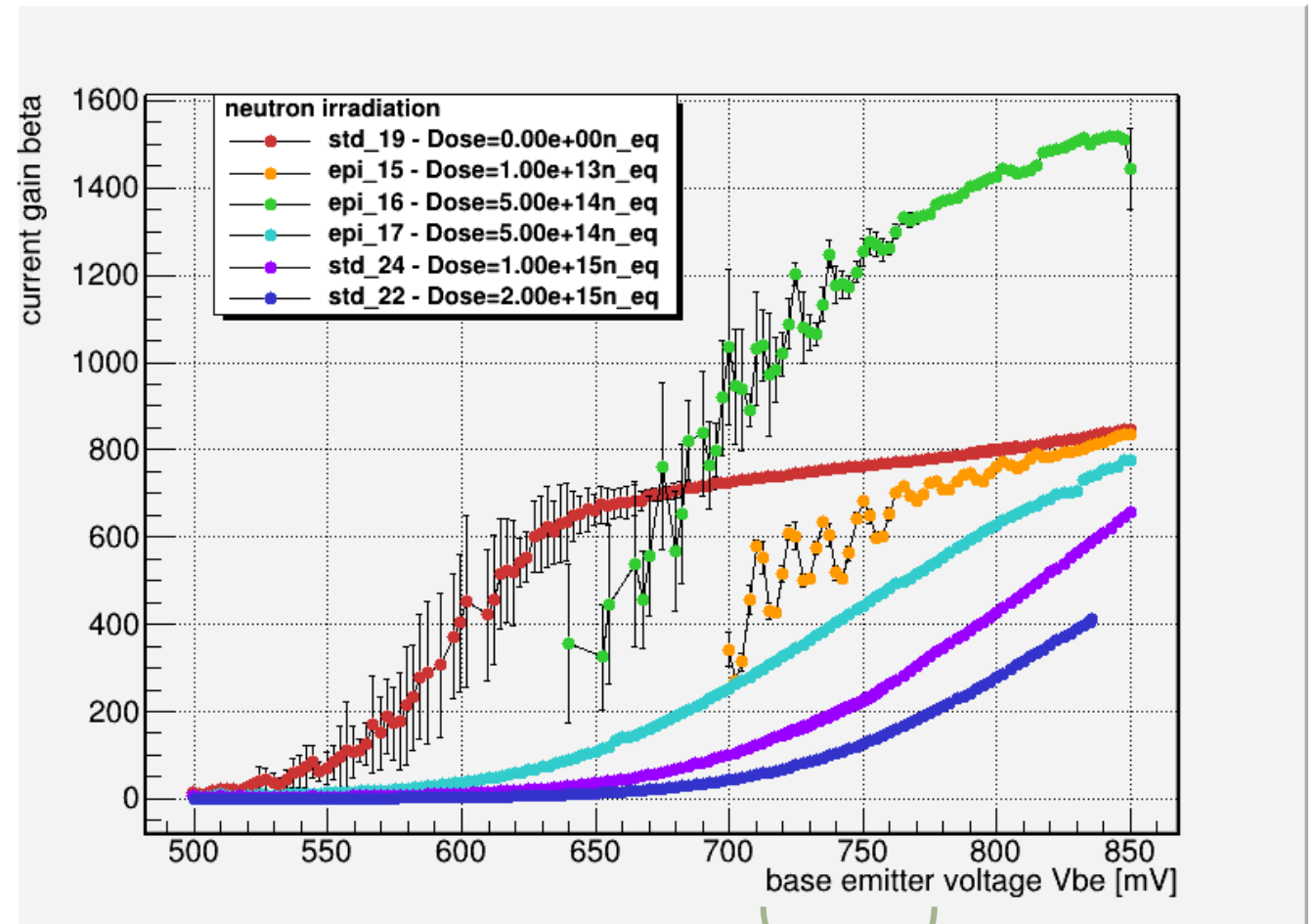


Results after irradiation

Findings:

- HBT can be still operated after irradiated with a large dose ($2e15 n_{eq}/cm^2$)
 - But the base current will increase significantly
 - Need to be considered already in the circuit design

$$\text{Current gain } \beta = \frac{I_c}{I_b}$$



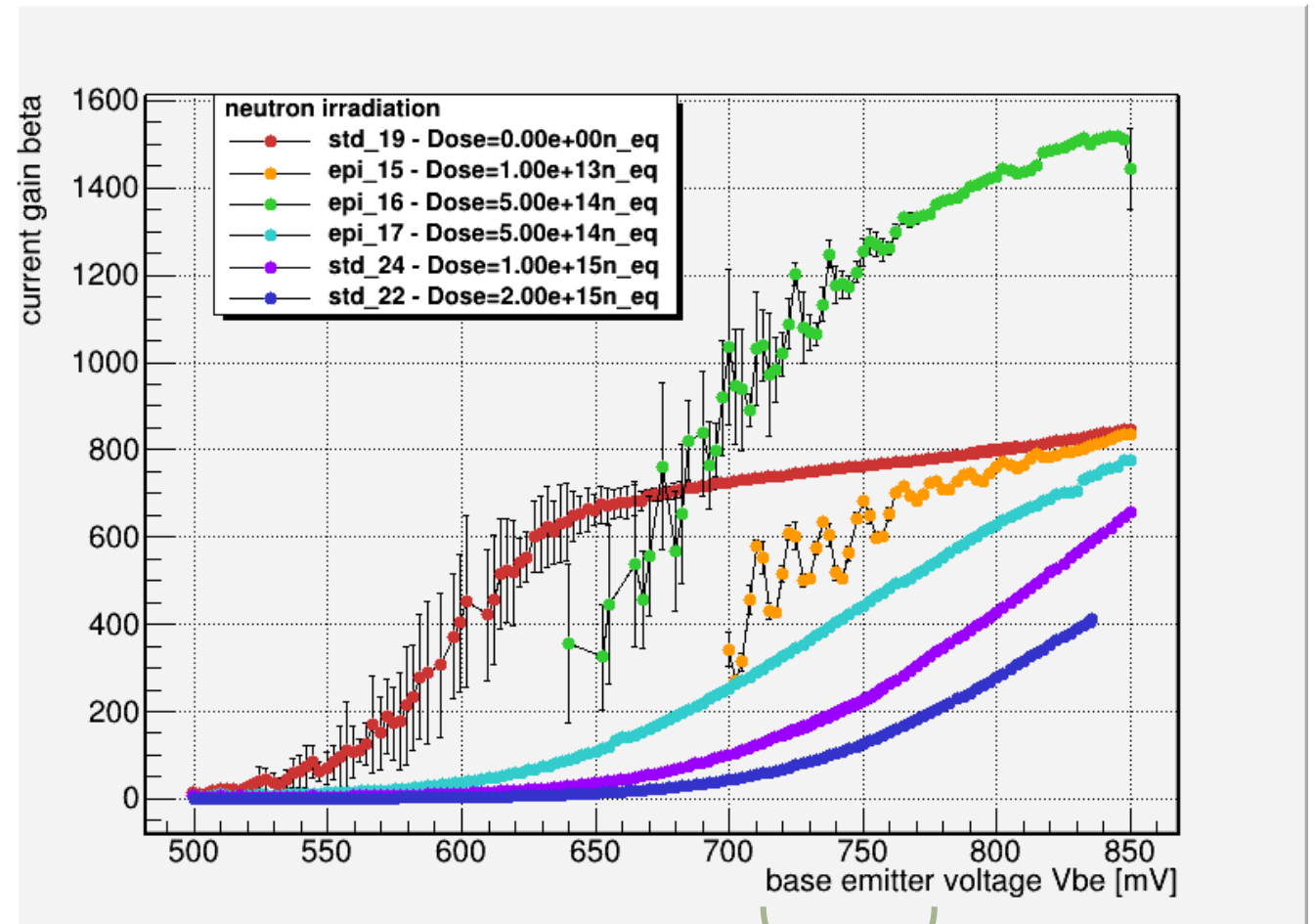
Typical operation range

Results after irradiation

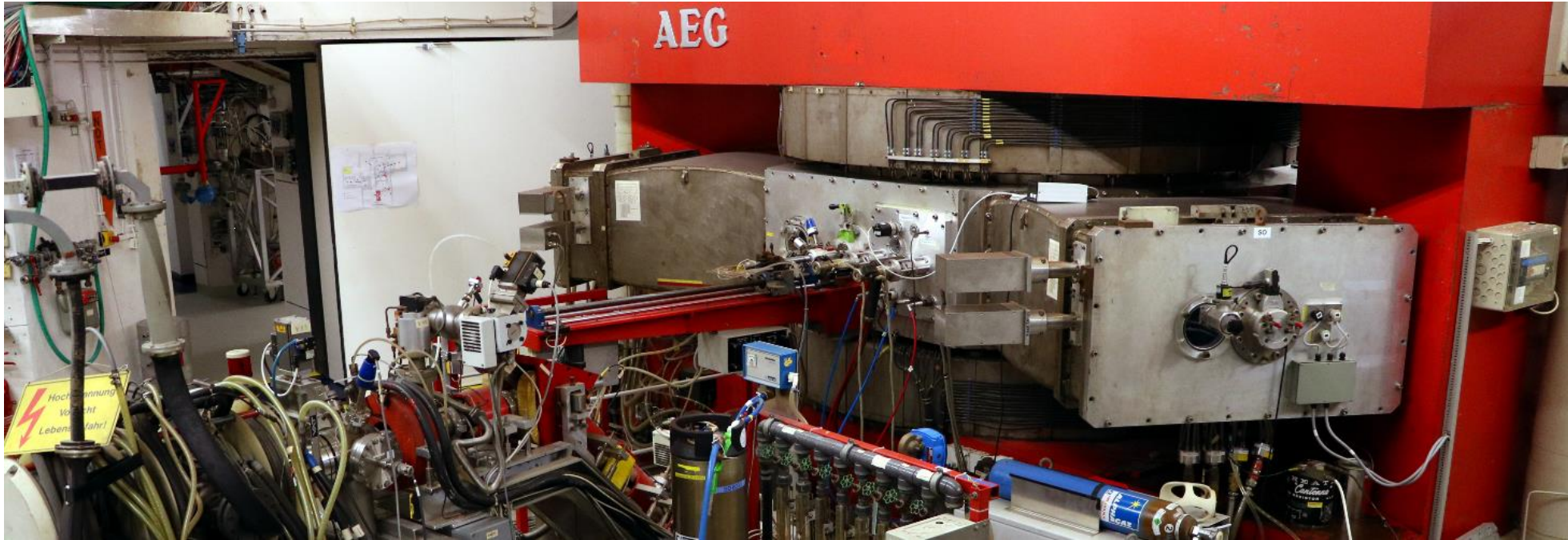
Problems:

- Reference measurements are missing to account for chip-to-chip variations
- Single Transistors are very vulnerable
 - Several were destroyed while testing
 - Limiting the statistics

$$\text{Current gain } \beta = \frac{I_c}{I_b}$$



Typical operation range



Proton irradiation

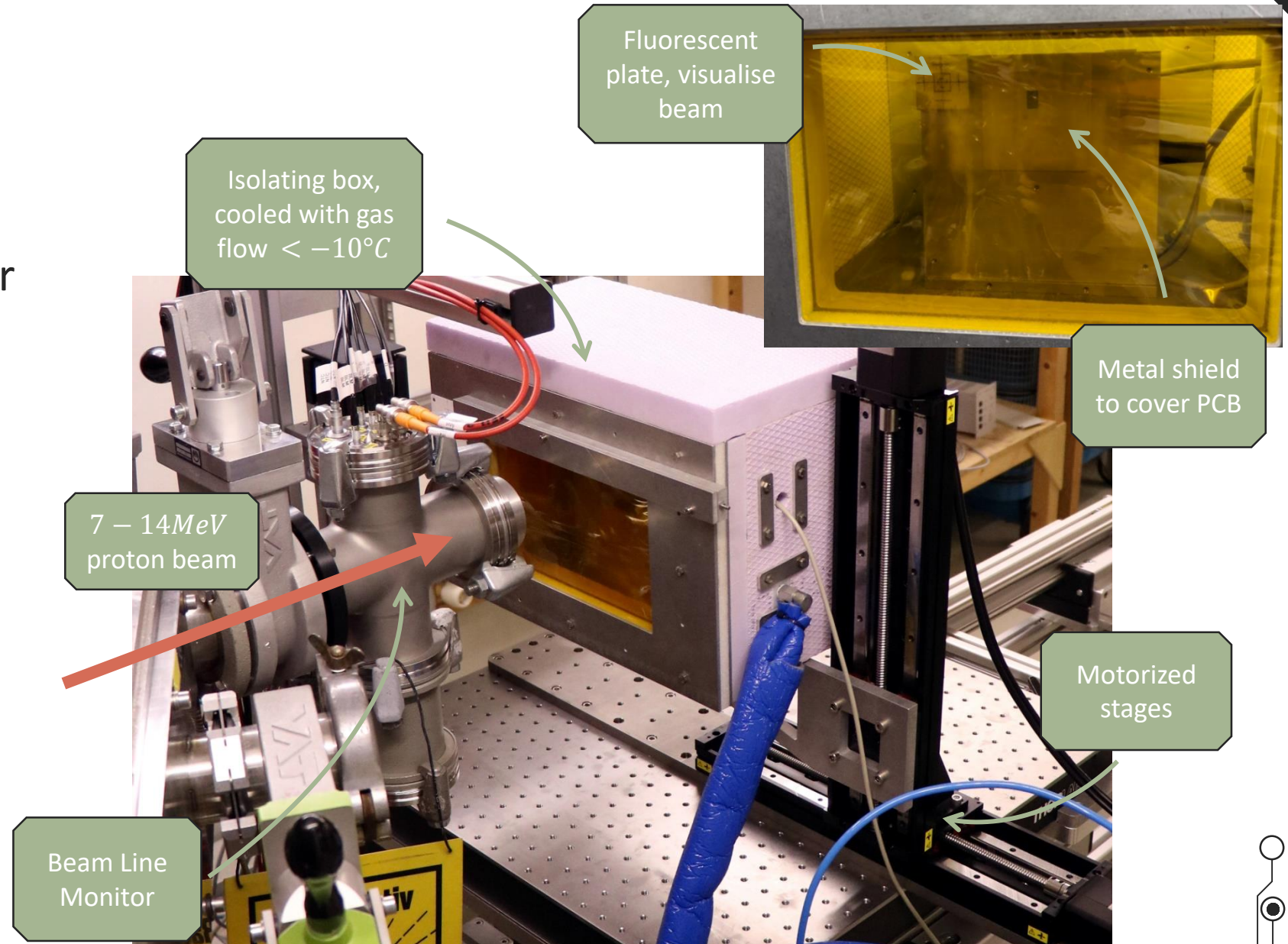
Irradiation at the Helmholtz-Institut für Strahlen- und Kernphysik in Bonn

Isochron-Zyklotron

Setup

- ~2h down time after irradiation
- 3-4h beam setup at each start-up

Measure same chip
in between of
irradiation steps

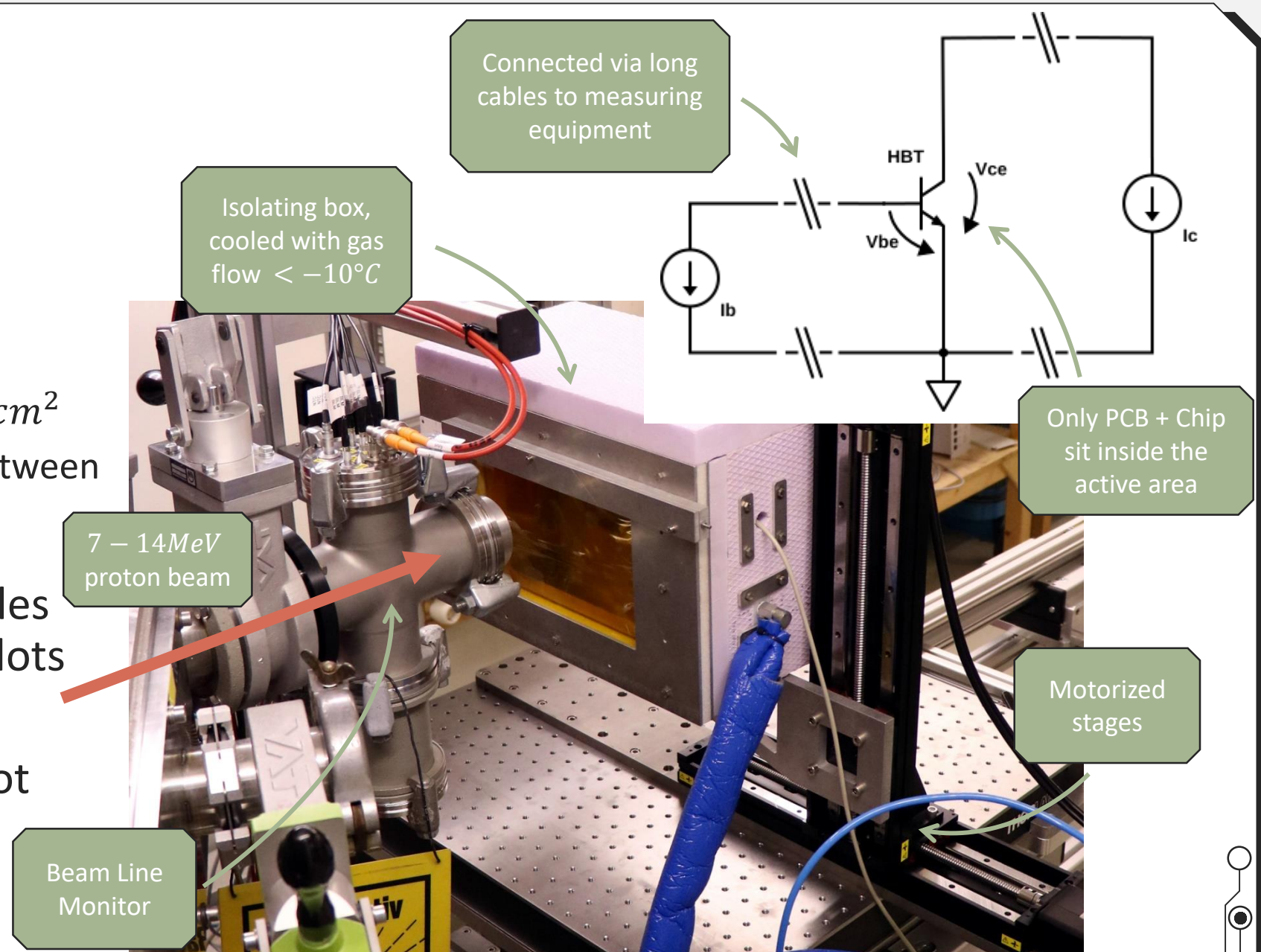


Setup

- 3 samples were measured
 - Up to $1.1e15 n_{eq}/cm^2$
 - With ~ 5 steps in between

Problems:

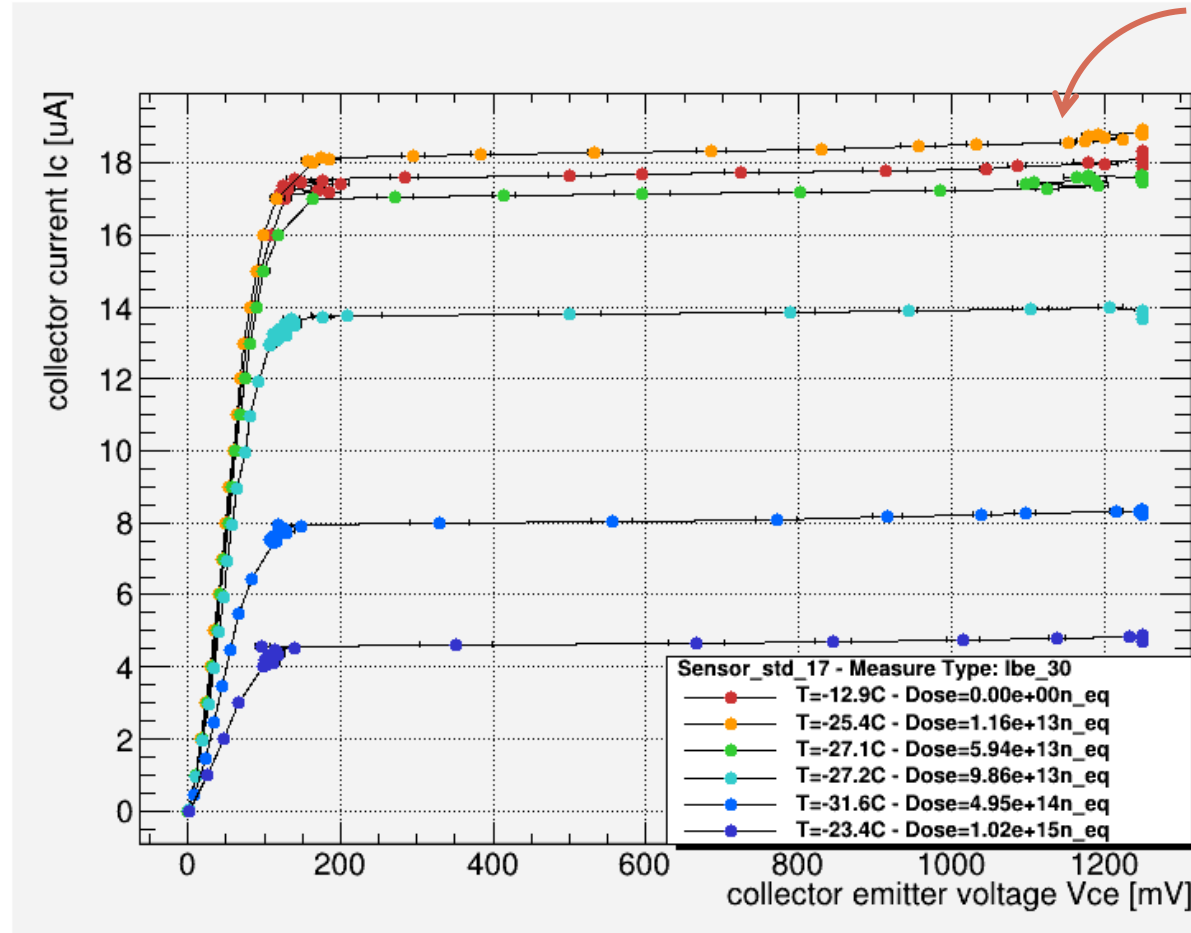
- Due to the long cables no Gummel-Poon plots could be produced
- Temperature was not really stable



Results after irradiation

- New measurement configuration:
 - Fixed value $I_b = 30\text{nA}$
 - Again β decreases with increasing dose
- I_c also decreases

Each curve is measured directly after an irradiation step

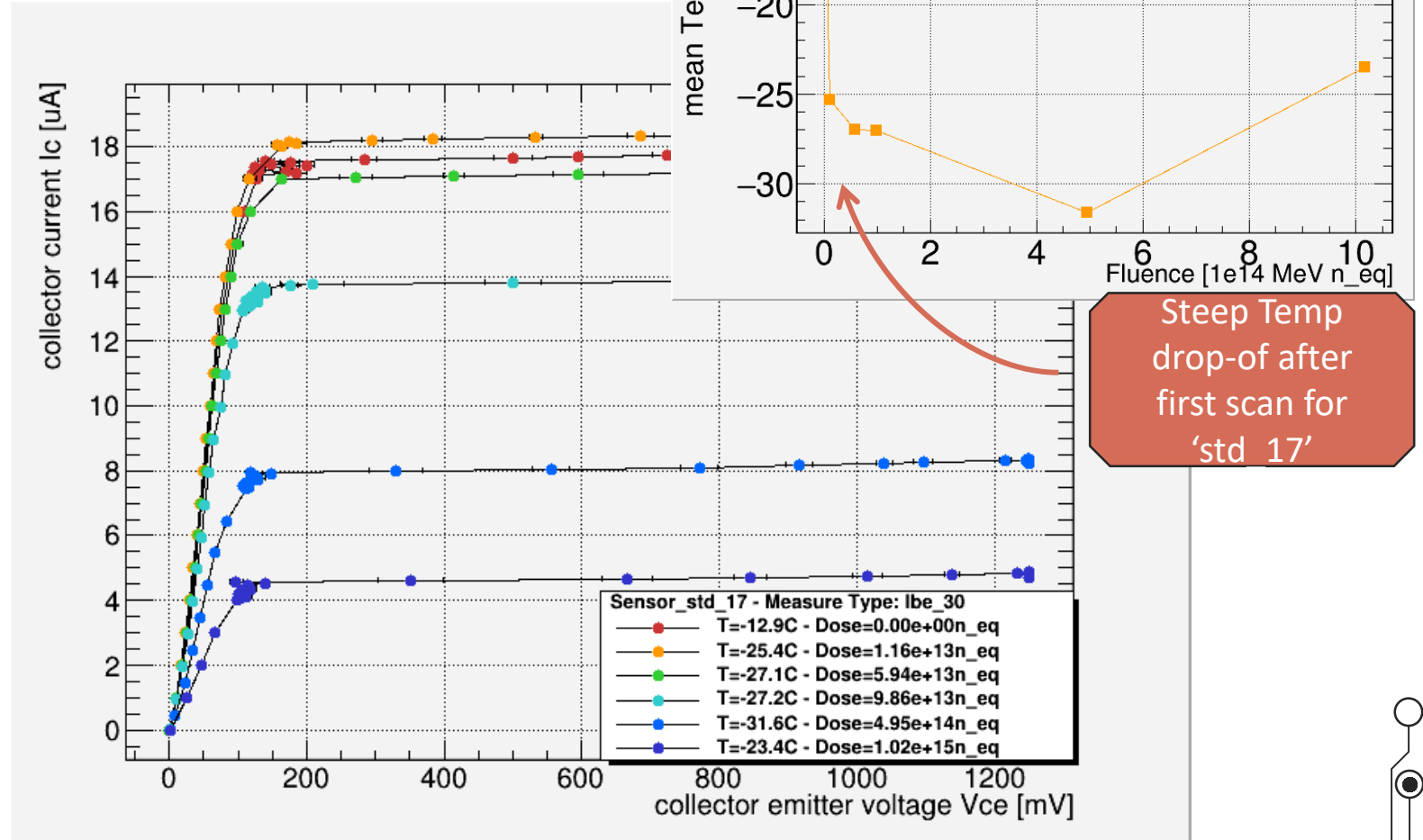


I_c increases after the first step?

Results after irradiation

- New measurement configuration:
 - Fixed value $I_b = 30\text{nA}$
 - Again β decreases with increasing dose
- I_c also decreases

Each curve is measured directly after an irradiation step

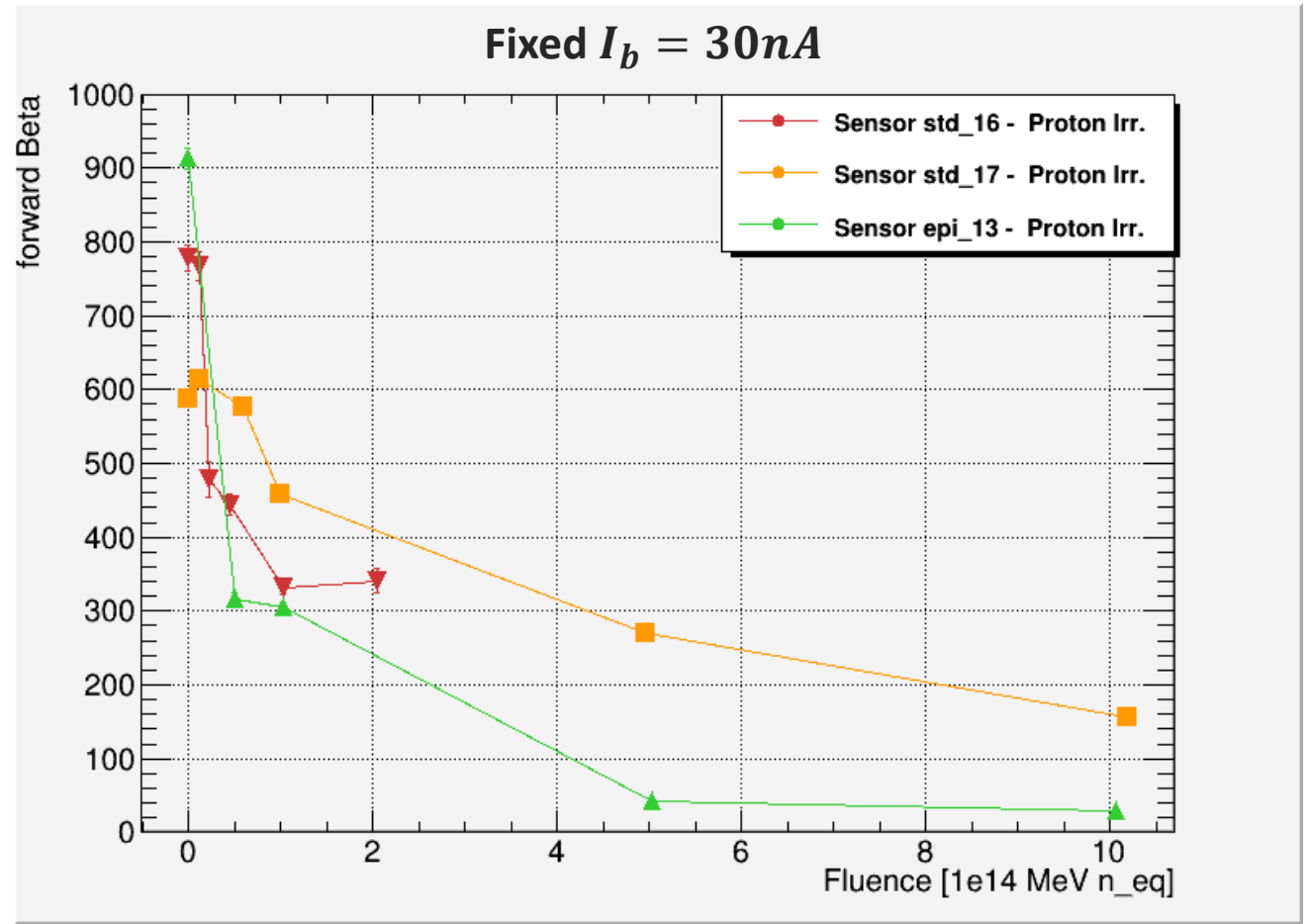


Steep Temp drop-of after first scan for 'std 17'

Results after irradiation

- For now: β is less temperate dependent
 - Most prominent dependencies from I_b and I_c cancel out
- Large chip-to-chip variation even before irradiation
- Steep performance decrease at low fluences

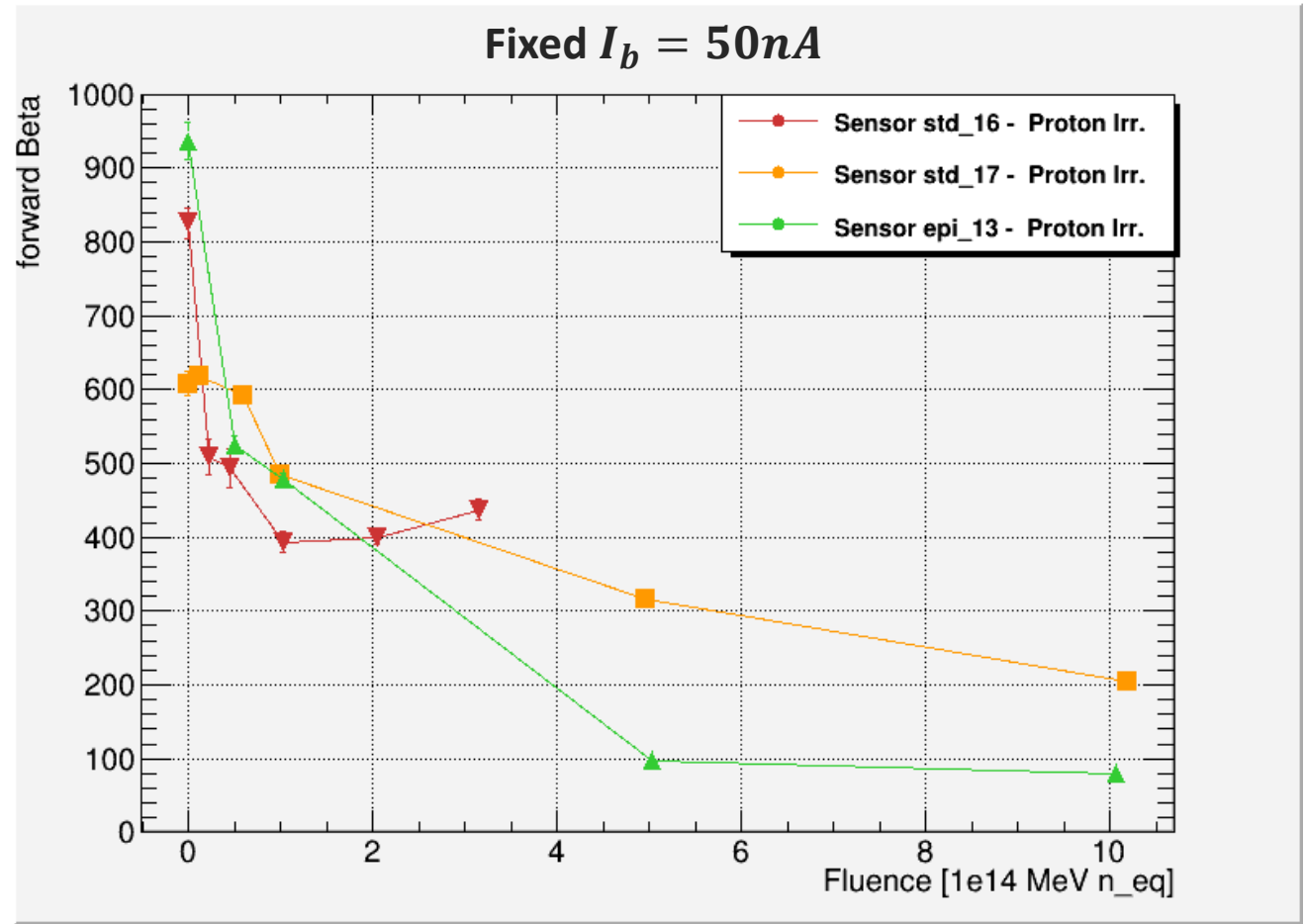
Keep in mind:
 $I_b = 30nA$
is a low power working
point



Results after irradiation

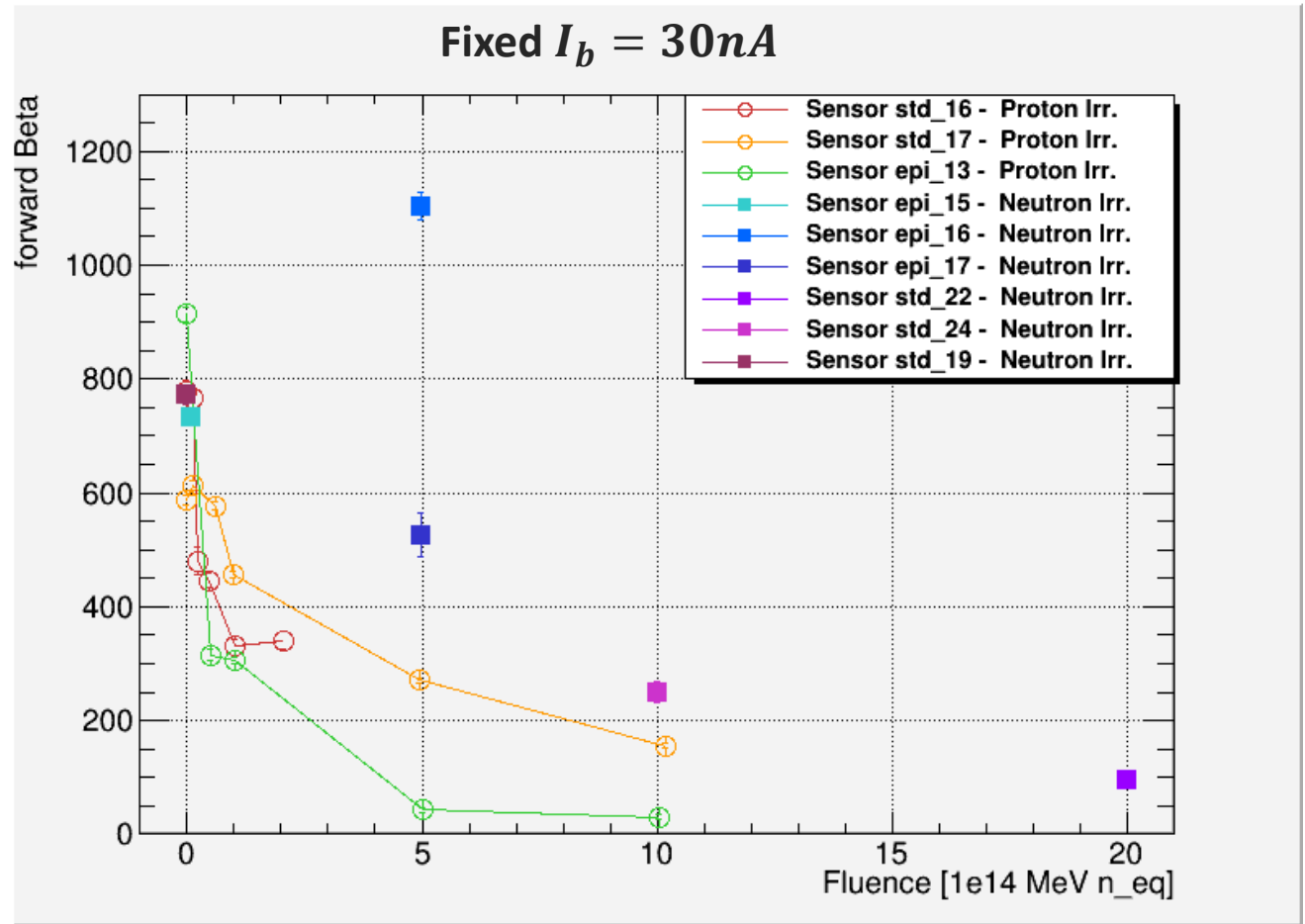
- For now: β is less temperate dependent
 - Most prominent dependencies from I_b and I_c cancel out
- Large chip-to-chip variation even before irradiation
- Steep performance decrease at low fluences

Performance increase already at $I_b = 50nA$



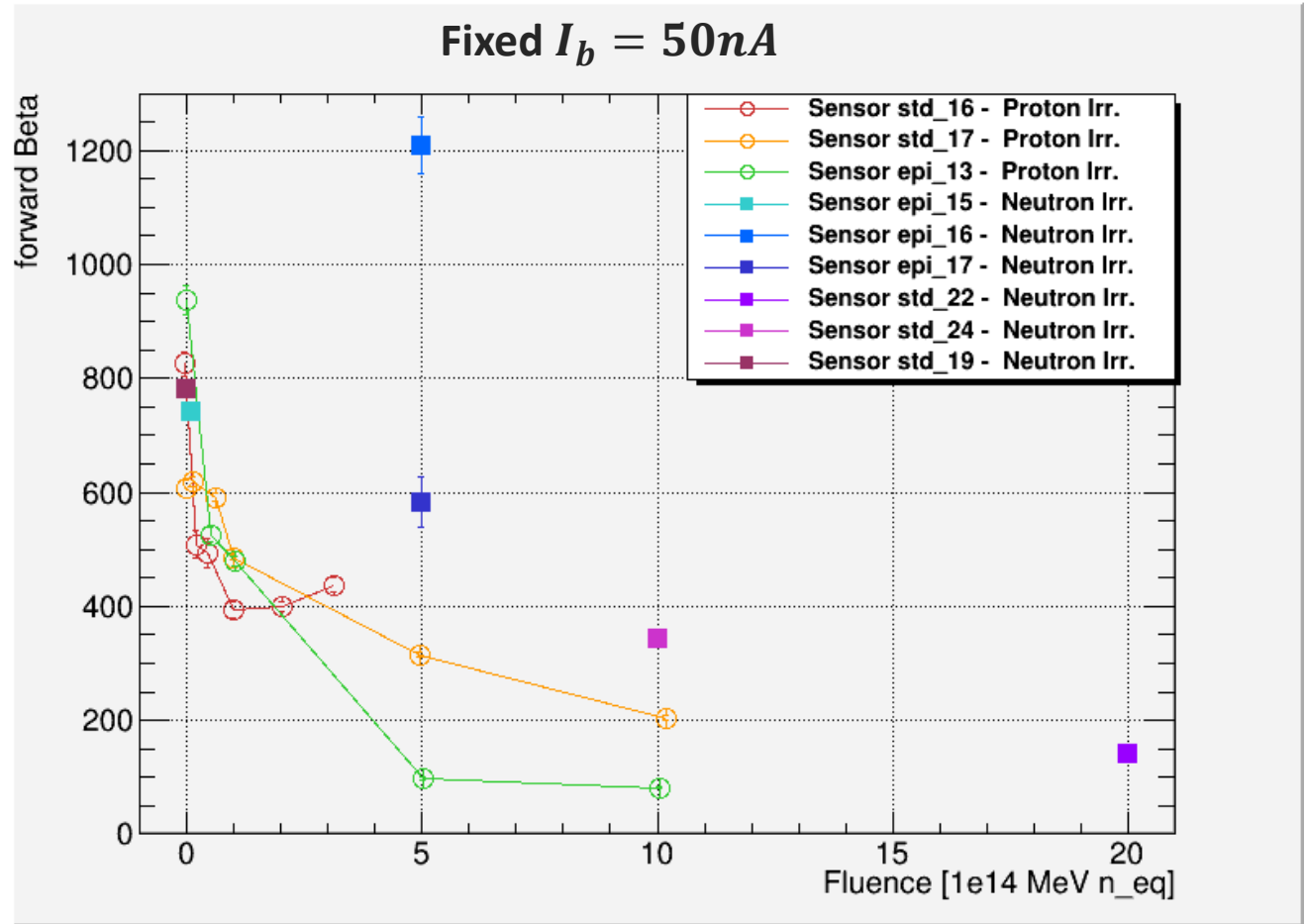
Neutrons vs Protons

- Proton seem to have an larger effect already at lower fluences
 - Additional Ionization damage
→ Influence should be minimal, since the HBT was not powered during irradiation
- Chip-to-chip variations have an huge influence
- Even after a large dose all samples are still working



Neutrons vs Protons

- Proton seem to have an larger effect already at lower fluences
 - Additional Ionization damage
→ Influence should be minimal, since the HBT was not powered during irradiation
- Chip-to-chip variations have an huge influence
- Even after a large dose all samples are still working



Lessons learned

Neutron irradiation

- Normally only possible to irradiate bare chips
 - Reference measurement not easy
 - ! Need to deal with chip-to-chip variations !
- In principle, an in-situ measurement at the **TRIGA Mark II** research reactor in Mainz would be possible
 - Large effort needed, to bring a setup close to the reactor

Lessons learned

Proton irradiation

- Measuring in between irradiation steps offers a lot potential
 - Having a large distance between measuring equipment and a fragile test structure can induce some problems
 - A better/ more stable temperature control would help a lot
- The cyclotron needs a long time to power on, 3-4h until everything is setup
- For next time: also irradiate while the device is powered
 - Was not done to reduce the risk of total failure of the samples

In general:

! Single transistor test structures are fragile !

What else can be done?

- There was no further investigation of the proton irradiated samples
 - Still stored in Bonn
- Annealing studies
 - Repeating the measurement after different annealing times
- The Samples also hold some test sensors
 - First results for a bandgap and a digital-to-analog circuit are already produced

References

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- Michael Moll, Radiation damage in silicon particle detectors: Microscopic defects and macroscopic properties. 1999, Hamburg
- Xiang-Ti Meng et al., Effects of neutron irradiation on SiGe HBT and Si BJT devices. 2003, DOI: 10.1023/A:1022977828563
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